

DATA SHEET

GENERAL PURPOSE CHIP RESISTORS

RC0805 (Pb Free)

5%; 1%











YAGEO



Chip Resistor Surface Mount

C

SERIES

0805 (Pb Free)

SCOPE

This specification describes RC0805 series chip resistors with lead-free terminations made by thick film process.

ORDERING INFORMATION

Part number is identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

YAGEO ORDERING CODE

CTC CODE

RC0805 X X X XX XXXX L

(1) (2) (3) (4) (5) (6

(I) TOLERANCE

 $F = \pm 1\%$ $| = \pm 5\%$

(2) PACKAGING TYPE

R = Paper/PE taping reel

(3) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec

(4) TAPING REEL

07 = 7 inch dia. Reel

10 = 10 inch dia. Reel (not preferred)

13 = 13 inch dia, Reel

(5) RESISTANCE VALUE

5R6, 56R, 560R, 5K6, 56K, 22M.

(6) RESISTOR TERMINATIONS

L = Lead free terminations (pure Tin)

ORDERING EXAMPLE

The ordering code of a RC0805 chip resistor, value 56 Ω with ±1% tolerance, supplied in 7-inch tape reel is: RC0805FR-0756RL.

NOTE

- I. The "L" at the end of the code is only for ordering. On the reel label, the standard CTC will be mentioned an additional stamp "LFP"= lead free production.
- 2. Products with lead in terminations fulfil the same requirements as mentioned in this datasheet.
- 3. Products with lead in terminations will be phased out in the coming months (before July 1st, 2006)





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MARKING

RC0805



E-24 series: 3 digits

First two digits for significant figure and 3rd digit for number of zeros



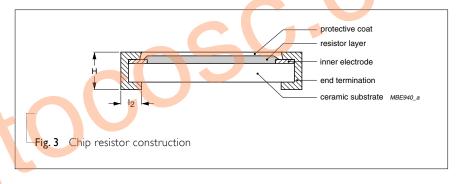
Both E-24 and E-96 series: 4 digits

First three digits for significant figure and 4th digit for number of zeros

For marking codes, please see EIA-marking code rules in data sheet "Chip resistors instruction".

CONSTRUCTION

The resistors are constructed out of a high-grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive paste. The composition of the paste is adjusted to give the approximate required resistance and laser cutting of this resistive layer that achieves tolerance trims the value. The resistive layer is covered with a protective coat and printed with the

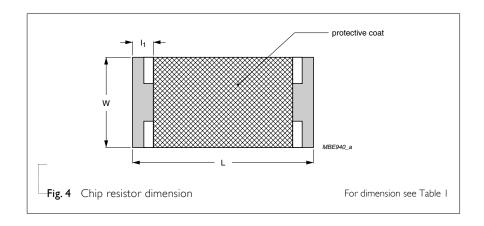


resistance value. Finally, the two external terminations (pure Tin) are added. See fig. 3.

DIMENSIONS

 a	bl	e	ı

TYPE	RC0805
L (mm)	2.00 ±0.10
W (mm)	1.25 ±0.10
H (mm)	0.50 ±0.10
I _I (mm)	0.35 ±0.20
l ₂ (mm)	0.35 ±0.20





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ELECTRICAL CHARACTERISTICS

Table 2

CHARACTERISTICS	I	RC0805 1/8 W
Operating Temperature Range	– 55	°C to +155 °C
Maximum Working Voltage		150 V
Maximum Overload Voltage		300 V
Dielectric Withstanding Voltage		300 V
	5% (E24)	I Ω to 22 M Ω
Resistance Range	1% (E96)	I Ω to I0 M Ω
	Zero Ohm Ju	umper < 0.05 Ω
Temperature Coefficient	$10~\Omega < R \le 10~M\Omega$	±100 ppm/°C
	$R \le 10 \Omega$; $R > 10 M\Omega$	±200 ppm/°C
Jumper Criteria	Rated Current	2.0 A
Jumper Criteria	Maximum Current	5.0 A

FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please see the special data sheet "Chip resistors mounting".

ENVIRONMENTAL DATA

For material declaration information (IMDS-data) of the products, please see the separated info "Environmental data".

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PRODUCT TYPE	PACKING STYLE	REEL DIMENSION	QUANTITY PER REEL
RC0805	Paper / PE Taping Reel (R)	7" (178 mm)	5,000 units
		10" (254 mm) / not preferred	10,000 units
	* ()	13" (330 mm)	20,000 units

NOTE

1. For Paper/PE tape and reel specification/dimensions, please see the special data sheet "Packing" document.



SERIES

FUNCTIONAL DESCRIPTION

POWER RATING

RC0805 rated power at 70°C is 1/8 W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$V=\sqrt{(P \times R)}$$

Where

V=Continuous rated DC or AC (rms) working voltage (V)

P=Rated power (W)

R=Resistance value (Ω)

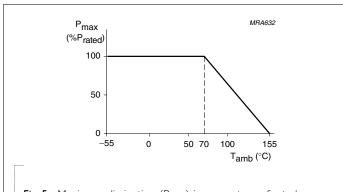


Fig. 5 Maximum dissipation (P_{max}) in percentage of rated power as a function of the operating ambient temperature (T_{amb})

PULSE LOADING CAPABILITIES

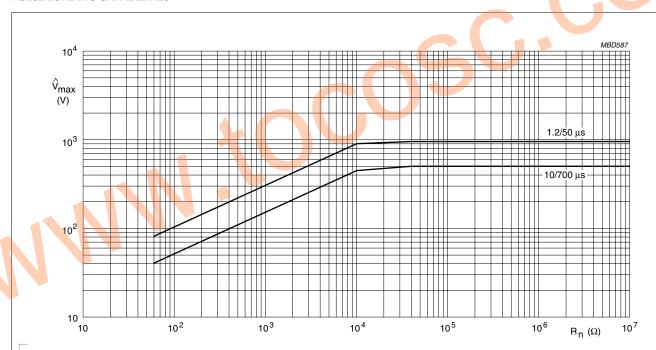


Fig. 6 Maximum permissible peak pulse voltage without failing to open circuit' in accordance with DIN IEC 60040 (CO) 533 for type: RC0805



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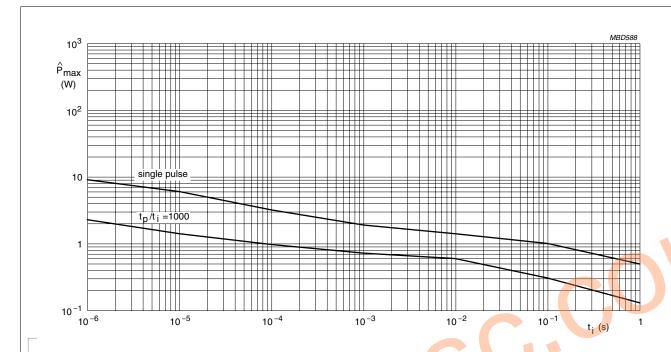


Fig. 7 Pulse on a regular basis for type: RC0805; maximum permissible peak pulse power as a function of pulse duration for single pulse and repetitive pulse tp/ti = 1000

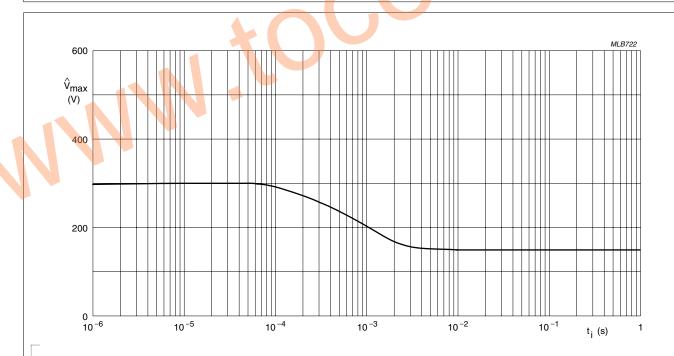


Fig. 8 Pulse on a regular basis for type: RC0805; maximum permissible peak pulse voltage as a function of pulse duration



TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

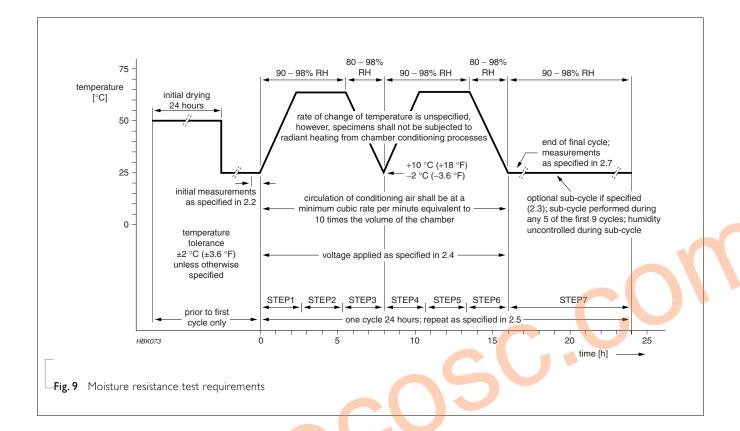
TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Temperature	MIL-STD-202F-method 304;	At +25/–55 °C and +25/+125 °C	Refer to table 3
Coefficient of Resistance	JIS C 5202-4.8	Formula:	
(T.C.R.)			
(1.6.14)		T.C.R= $\frac{R_2-R_1}{R_1(t_2-t_1)} \times 10^6 \text{ (ppm/°C)}$	
		Where	
		t ₁ =+25 °C or specified room temperature	
		t ₂ =–55 °C or +125 °C test temperature	
		R ₁ =resistance at reference temperature in ohms	
		R ₂ =resistance at test temperature in ohms	
Thermal Shock	MIL-STD-202F-method 107G;	At -65 (+0/-10) °C for 2 minutes and at +155	$\pm (0.5\% + 0.05 \ \Omega)$ for 1% tol.
	IEC 60115-1 4.19	(+10/-0) °C for 2 minutes; 25 cycles	$\pm (1.0\% + 0.05 \Omega)$ for 5% tol.
		·	
Low	MIL-R-55342D-Para 4.7.4	At –65 (+0/–5) °C for I hour, RCWV applied	$\pm (0.5\% + 0.05 \ \Omega)$ for 1% tol .
Temperature		for 45 (+5/–0) minutes	\pm (1.0%+0.05 Ω) for 5% tol.
Operation			No visible damage
Short Time	MIL-R-55342D-Para 4.7.5;	2.5 × RCWV applied for 5 seconds at room	$\pm (1.0\% + 0.05 \ \Omega)$ for 1% tol.
Overload	IEC 60115-1 4.13	tempe <mark>ra</mark> ture	$\pm (2.0\% + 0.05 \ \Omega)$ for 5% tol.
	- 11		No visible damage
Insulation	MIL-STD-202F-method 302;	RCOV for 1 minute	≥10 GΩ
Resistance	IEC 60115-1 4.6.1.1	Type RC0805	
		Voltage (DC) 300 V	
Dielectric	MIL-STD-202F-method 301;	Maximun voltage (V _{rms}) applied for 1 minute	No breakdown or flashover
Withstand	MIL-STD-202F-method 301; IEC 60115-1 4.6.1.1	Maximun voltage (V _{rms}) applied for 1 minute Type RC0805	No breakdown or flashover
			No breakdown or flashover
Withstand Voltage	IEC 60115-1 4.6.1.1	Type RC0805 Voltage (AC) 300 V _{rms}	
Withstand Voltage Resistance to	IEC 60115-1 4.6.1.1 MIL-STD-202F-method 210C;	Type RC0805	$\pm (0.5\% + 0.05~\Omega)$ for 1% tol.
Withstand Voltage	IEC 60115-1 4.6.1.1	Type RC0805 Voltage (AC) 300 V_{rms} Unmounted chips; $260 \pm 5 \text{ °C for } 10 \pm 1 \text{ °C}$	$\pm (0.5\% + 0.05 \ \Omega)$ for 1% tol. $\pm (1.0\% + 0.05 \ \Omega)$ for 5% tol.
Withstand Voltage Resistance to Soldering	IEC 60115-1 4.6.1.1 MIL-STD-202F-method 210C;	Type RC0805 Voltage (AC) 300 V_{rms} Unmounted chips; $260 \pm 5 \text{ °C for } 10 \pm 1 \text{ °C}$	$\pm (0.5\% + 0.05~\Omega)$ for 1% tol.
Withstand Voltage Resistance to Soldering	IEC 60115-1 4.6.1.1 MIL-STD-202F-method 210C;	Type RC0805 Voltage (AC) 300 V_{rms} Unmounted chips; $260 \pm 5 \text{ °C for } 10 \pm 1 \text{ °C}$	$\pm (0.5\% + 0.05 \ \Omega)$ for 1% tol. $\pm (1.0\% + 0.05 \ \Omega)$ for 5% tol.



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ST	TEST METHOD	PROCEDURE	REQUIREMENTS	
Solderability	MIL-STD-202F-method 208A;	Solder bath at 245±3 °C	Well tinned (≥95% cove	ered)
	IEC 60115-1 4.17	Dipping time: 2±0.5 seconds	No visible damage	
Bending	JIS C 5202.6.14;	Resistors mounted on a 90 mm glass epoxy	\pm (1.0%+0.05 Ω) for 1%	í tol.
Strength	IEC 60115-1 4.15	resin PCB (FR4)	$\pm (1.0\% + 0.05 \ \Omega)$ for 5% tol. No visible damage	
		Bending: 5 mm		
Resistance to	MIL-STD-202F-method 215;	Isopropylalcohol (C ₃ H ₇ OH) or dichloromethane	No smeared	
Solvent	IEC 60115-1 4.29	(CH ₂ Cl ₂) followed by brushing		
Noise	JIS C 5202 5.9;	Maximum voltage (V _{ms}) applied.	Resistors range	Value
	IEC 60115-1 4.12		R < 100 Ω	10 dB
			$100 \Omega \le R < 1 K\Omega$	20 dB
			I KΩ ≤ R < 10 KΩ	30 dB
			10 KΩ ≤ R < 100 KΩ	40 dE
			$100 \text{ K}\Omega \leq R < 1 \text{ M}\Omega$	46 dE
			$M\Omega \le R \le 22 M\Omega$	48 dE
11	IIS C 5202 7 5	1000 have 4012 9C 02(12/ 2)9/ DII		
Humidity	JIS C 5202 7.5;	1,000 hours; 40±2 °C; 93(+2/–3)% RH	±(0.5%+0.05 Ω) for 1%	í tol.
Humidity (steady state)	JIS C 5202 7.5; IEC 60115-8 4.24.8	I,000 hours; 40±2 °C; 93(+2/-3)% RH RCWV applied for I.5 hours on and 0.5 hour off	\pm (0.5%+0.05 Ω) for 1% \pm (2.0%+0.05 Ω) for 5%	
•			,	
(steady state)	IEC 60115-8 4,24.8	RCWV applied for 1.5 hours on and 0.5 hour off	$\pm (2.0\% + 0.05 \ \Omega)$ for 5%	
Leaching Intermittent	IEC 60115-8 4.24.8	RCWV applied for 1.5 hours on and 0.5 hour off Solder bath at 260 ± 5 °C Dipping time: 30 ± 1 seconds	$\pm (2.0\% + 0.05 \ \Omega)$ for 5%	s tol.
(steady state) Leaching	IEC 60115-8 4.24.8 EIAVIS 4.13B; IEC 60115-8 4.18	RCWV applied for 1.5 hours on and 0.5 hour off Solder bath at 260 ± 5 °C Dipping time: 30 ± 1 seconds	$\pm (2.0\% + 0.05 \ \Omega)$ for 5% No visible damage	s tol.
Leaching Intermittent	IEC 60115-8 4.24.8 EIAVIS 4.13B; IEC 60115-8 4.18	RCWV applied for 1.5 hours on and 0.5 hour off Solder bath at 260±5 °C Dipping time: 30±1 seconds At room temperature; 2.5 × RCWV applied for 1 second on and 25 seconds off; total 10,000	$\pm (2.0\% + 0.05~\Omega)$ for 5% No visible damage $\pm (1.0\% + 0.05~\Omega)$ for 1%	s tol.
Leaching Intermittent Overload Resistance to	IEC 60115-8 4.24.8 EIAVIS 4.13B; IEC 60115-8 4.18 JIS C 5202 5.8	RCWV applied for 1.5 hours on and 0.5 hour off Solder bath at 260±5 °C Dipping time: 30±1 seconds At room temperature; 2.5 × RCWV applied for 1 second on and 25 seconds off; total 10,000 cycles	$\pm (2.0\% + 0.05~\Omega)$ for 5% No visible damage $\pm (1.0\% + 0.05~\Omega)$ for 1%	6 tol.
Leaching Intermittent Overload Resistance to Vibration	IEC 60115-8 4.24.8 EIAVIS 4.13B; IEC 60115-8 4.18 JIS C 5202 5.8 On request	RCWV applied for 1.5 hours on and 0.5 hour off Solder bath at 260±5 °C Dipping time: 30±1 seconds At room temperature; 2.5 × RCWV applied for 1 second on and 25 seconds off; total 10,000 cycles On request	$\pm (2.0\% + 0.05~\Omega)$ for 5% No visible damage $\pm (1.0\% + 0.05~\Omega)$ for 1% $\pm (2.0\% + 0.05~\Omega)$ for 5%	5 tol. 5 tol. 5 tol.

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REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 2	Sep 03, 2004	=	- Test method and procedure updated
			- PE tape added (paper tape will be replaced by PE tape)

